

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

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In re Patent Application of:  
Hung-Wen SU et al.

Application No.: 10/814,175

Confirmation No.: 7374

Filed: April 1, 2004

Art Unit: 1795

For: METHOD AND APPARATUS FOR  
ELECTROPLATING

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Examiner: E. Wong

**REPLY TO RESTRICTION REQUIREMENT**

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

In reply to the Restriction Requirement dated September 26, 2007, the following remarks are respectfully submitted in connection with the above-identified application.

**REMARKS**

Claims 1-23 are pending in the present application.

The Examiner has required election in the present application between:

Group I, claims 1-8, drawn to an apparatus for metal electroplating;

Group II, claims 9-14, drawn to a method of metal electroplating; and

Group III, claims 15-23, drawn to a method of metal electroplating.

**For the purpose of examination of the present application, Applicants elect, with traverse, Group I, Claims 1-8.**